PCN Number:		20231106000.1					I	PCN Date:		November 09, 2023		
Title:												
Customer Contact:			Chai	nge l	Management	t tea	am	Dept	t:		Qua	lity Services
Proposed 1 st Ship Date:			Feb 9, 2024				Sample Requests accepted until:				Dec	9, 2023*
_	-	ts received	afte	r De	c <mark>9, 2023</mark> w	vill r	ot be su	uppo	ort	ed.		
Change												
	embly Site				Design Data Shee	-			╡	Wafer Bump Material		
	embly Pro embly Mat						hando				r Bump Process r Fab Site	
		pecification		Part number change Test Site			╡	Wafer Fab Material				
		ping/Labeling]		Test Process		Ē	5	Wafer Fab Process			
					PCN De	etai	s					
Descrip	tion of Cl	hange:										
		orm of an alt sections bel		e Mo	ount Compo	und	material	set f	for	r the list	c of d	evices in the
	W	hat			Curre	ent			Additional			
	Mount C	ompound			4205	846				4	2114	70
Qualification results are shown below												
Reason	for Chan	ge:										
Standar	Standardization											
Anticipa	ated impa	act on Form	ı, Fit,	, Fur	nction, Qua	lity	or Relia	bility	y (positiv	e / n	egative):
None					, .							5 /
Impact	Impact on Environmental Ratings											
Checked boxes indicate the status of environmental ratings following implementation of this change. If below boxes are checked, there are no changes to the associated environmental ratings.												
RoHS			R	EAC	H		Green St	tatus	5			C 62474
🛛 No Change 🛛 🕅			No Ch	Change 🛛 🛛 No Change			je	🛛 No Change			nange	
Changes to product identification resulting from this PCN:												
None												
Product Affected:												
ACF2101BU DAC716		7 <u>16U</u> B	6UB DAG			7802KU/1K			INA1	16UA		
ADS774JU DAC7		716UK	6UK DAC78						INA2	128U		
ADS774JU/1K			7614U	L4U DAC			311JU				128U/	′1K
			7614U	U/1K DAC811KU			1KU IN			, 128U		
ADS774KU/1K			7614U		DAC813AU						128U/	
AUS//4	ADS774KU/1K			ıВ	DA	4081	L3AU			INA2	1280/	A/1K

ADS7800JU	DAC7614UB/1K	DAC813AU/1K	INA2141U
ADS7800JU/1K	DAC7615U	DAC813JU	INA2141UA
ADS7800KU	DAC7615U/1K	DAC813JU/1K	INA2141UA/1K
ADS7804U	DAC7615UB	DAC813KU	INA217AIDWR
ADS7804U/1K	DAC7615UB/1K	DAC8830IBD	INA217AIDWT
ADS7804UB	DAC7616UB	DAC8830IBDR	LOG2112AIDW
ADS7805U	DAC7616UB/1K	DAC8830ICD	LOG2112AIDWR
ADS7805U/1K	DAC7617UB	DAC8830ICDR	MPY634KU
ADS7805UB	DAC7624U	DAC8830ID	MPY634KU/1K
ADS7805UB/1K	DAC7624U/1K	DAC8830IDR	OPA404KU
ADS7806UB	DAC7624UB	DAC8830MCDEP	OPA404KU/1K
ADS7807U	DAC7624UB/1K	DAC8830MCDREP	OPA4131UA
ADS7807U/1K	DAC7625U	DAC8831IBD	OPA4131UA/1K
ADS7807UB	DAC7625U/1K	DAC8831IBDR	PCM56U
ADS7811U	DAC7625UB	DAC8831ICD	PCM56U/1K
ADS7811U-1/1K	DAC7625UB/1K	DAC8831ICDR	PGA204AU
ADS7812UB	DAC7714U	DAC8831ID	PGA204AU/1K
ADS7812UB/1K	DAC7714U/1K	DAC8831IDR	PGA204BU
ADS7813U	DAC7714UB	DAC8831MCDEP	PGA204BU/1K
ADS7813U/1K	DAC7714UB/1K	DAC8831MCDREP	PGA205AU
ADS7813UB	DAC7715U	DDC101U	PGA205AU/1K
ADS7815U	DAC7715U/1K	DRV134UA	PGA205BU
ADS7815U/1K	DAC7715UB	DRV134UA/1K	PGA206UA
ADS7824U	DAC7715UB/1K	INA101KU	PGA207UA
ADS7824U/1K	DAC7724U	INA101KU/1K	PGA207UA/1K
ADS7824UB	DAC7724U/1K	INA103KU	PGA2310UA
ADS7825U	DAC7724UB	INA103KU/1K	PGA2310UA/1K
ADS7825U/1K	DAC7724UB/1K	INA110KU	PGA2311U
ADS7825UB	DAC7725U	INA111AU	PGA2311U/1K
ADS7825UB/1K	DAC7725UB	INA111AU/1K	PGA2311UA
ADS8512IBDW	DAC7725UB/1K	INA111BU	PGA2311UA/1K
ADS8513IBDW	DAC7800KU	INA114AU	PGA2320IDW
ADS8513IBDWR	DAC7800KU/1K	INA114AU/1K	PGA2320IDWR
ADS8513IDW	DAC7800LU	INA114BU	UAF42AU
ADS8513IDWR	DAC7801KU	INA114BU/1K	XTR101AU
DAC714U	DAC7801KU/1K	INA115AU	XTR101AU/1K
DAC714U/1K	DAC7801LU	INA115AU/1K	XTR110KU
DAC715UB	DAC7802KU	INA115BU	XTR110KU/1K
DAC715UL			

Qualification Report

Approve Date 22-September-2023

Qualification Results

Data Displayed as: Number of lots / Total sample size / Total failed

Туре	#	Test Name	Condition	Duration	Qual Device: <u>PGA2320IDWR</u>	QBS Reference: ISO6721BQDRQ1
HAST	A2	Biased HAST	130C/85%RH	96 Hours	-	3/231/0
UHAST	A3	Autoclave	121C/15psig	96 Hours	-	3/231/0
UHAST	A3	Unbiased HAST	130C/85%RH	96 Hours	3/231/0	-
тс	A4	Temperature Cycle	-65C/150C	500 Cycles	3/231/0	3/231/0
HTSL	A6	High Temperature Storage Life	170C	420 Hours	3/231/0	-
HTSL	A6	High Temperature Storage Life	175C	500 Hours	-	3/135/0
HTOL	B1	Life Test	125C	1000 Hours	-	3/231/0
SD	C3	PB Solderability	Precondition w.155C Dry Bake (4 hrs +/- 15 minutes)	-	-	1/15/0
SD	C3	PB-Free Solderability	Precondition w.155C Dry Bake (4 hrs +/- 15 minutes)	-	1/22/0	1/15/0
PD	C4	Physical Dimensions	Cpk>1.67	-	-	3/30/0
ESD	E2	ESD CDM		500 Volts	-	1/3/0
ESD	E2	ESD HBM	-	2000 Volts	-	1/3/0
LU	E4	Latch-Up	Per JESD78	-	-	1/6/0

Туре	#	Test Name	Condition	Duration	Qual Device: <u>PGA2320IDWR</u>	QBS Reference: ISO6721BQDRQ1
CHAR	E5	Electrical Characterization	Per Datasheet Parameters	-	3/90/0	-
CHAR	E5	Electrical Distributions	Cpk>1.67 Room, hot, and cold	-	-	3/90/0

· QBS: Qual By Similarity

Qual Device PGA2320IDWR is qualified at MSL2 260C

· Preconditioning was performed for Autoclave, Unbiased HAST, THB/Biased HAST, Temperature Cycle, Thermal Shock, and HTSL, as applicable

The following are equivalent HTOL options based on an activation energy of 0.7eV : 125C/1k Hours, 140C/480 Hours, 150C/300 Hours, and 155C/240 Hours

The following are equivalent HTSL options based on an activation energy of 0.7eV : 150C/1k Hours, and 170C/420 Hours

• The following are equivalent Temp Cycle options per JESD47 : -55C/125C/700 Cycles and -65C/150C/500 Cycles

Quality and Environmental data is available at TI's external Web site: http://www.ti.com/

TI Qualification ID: R-CHG-2304-021

For questions regarding this notice, e-mails can be sent to the Change Management team or your local Field Sales Representative.

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